

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0736565000

Status:

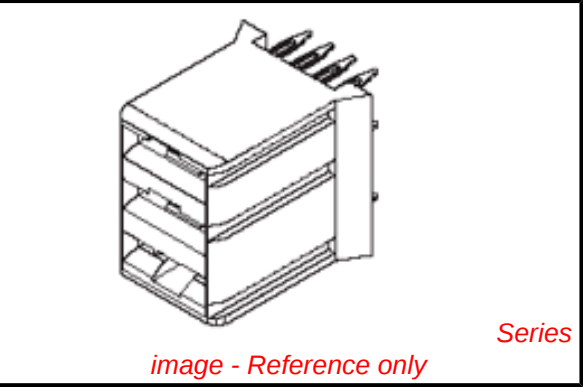
Active

Overview:

[hdm](#)

Description:

2.00mm (.079") Pitch HDM® Board-to-Board Backplane Power Module, Vertical, SMC, Power Receptacle, 3 Circuits



Documents:

[3D Model](#)

[RoHS Certificate of Compliance \(PDF\)](#)

[Product Specification PS-73670-9999 \(PDF\)](#)

General	
Product Family	Backplane Connectors
Series	73656
Application	Backplane
Comments	Midplane Power Module, Molex Series 73659
Component Type	Power Header
Overview	hdm
Product Name	HDM®
Style	N/A
Physical	
Circuits (Loaded)	3
Circuits (maximum)	3
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Beryllium Copper
Material - Plating Mating	Gold
Material - Plating Termination	Gold
Material - Resin	High Temperature Thermoplastic
Number of Columns	1
Number of Pairs	Open Pin Field
Number of Rows	3
Orientation	Vertical
PC Tail Length (in)	0.138 In
PC Tail Length (mm)	3.50 mm
PCB Locator	No
PCB Retention	Yes
PCB Thickness Recommended (in)	0.098 In
PCB Thickness Recommended (mm)	2.50 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.000 In
Pitch - Mating Interface (mm)	0.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	2
Plating min: Termination (µm)	0.05
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

EU RoHS

RoHS Compliant by Exemption

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Not Reviewed

China RoHS



Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

73656Series

Mates With

73651 HDM® Board-to-Board Daughterboard Power Module

Current - Maximum per Contact	15A
Data Rate	1.0 Gbps
Shielded	No
Voltage - Maximum	500V AC

Material Info

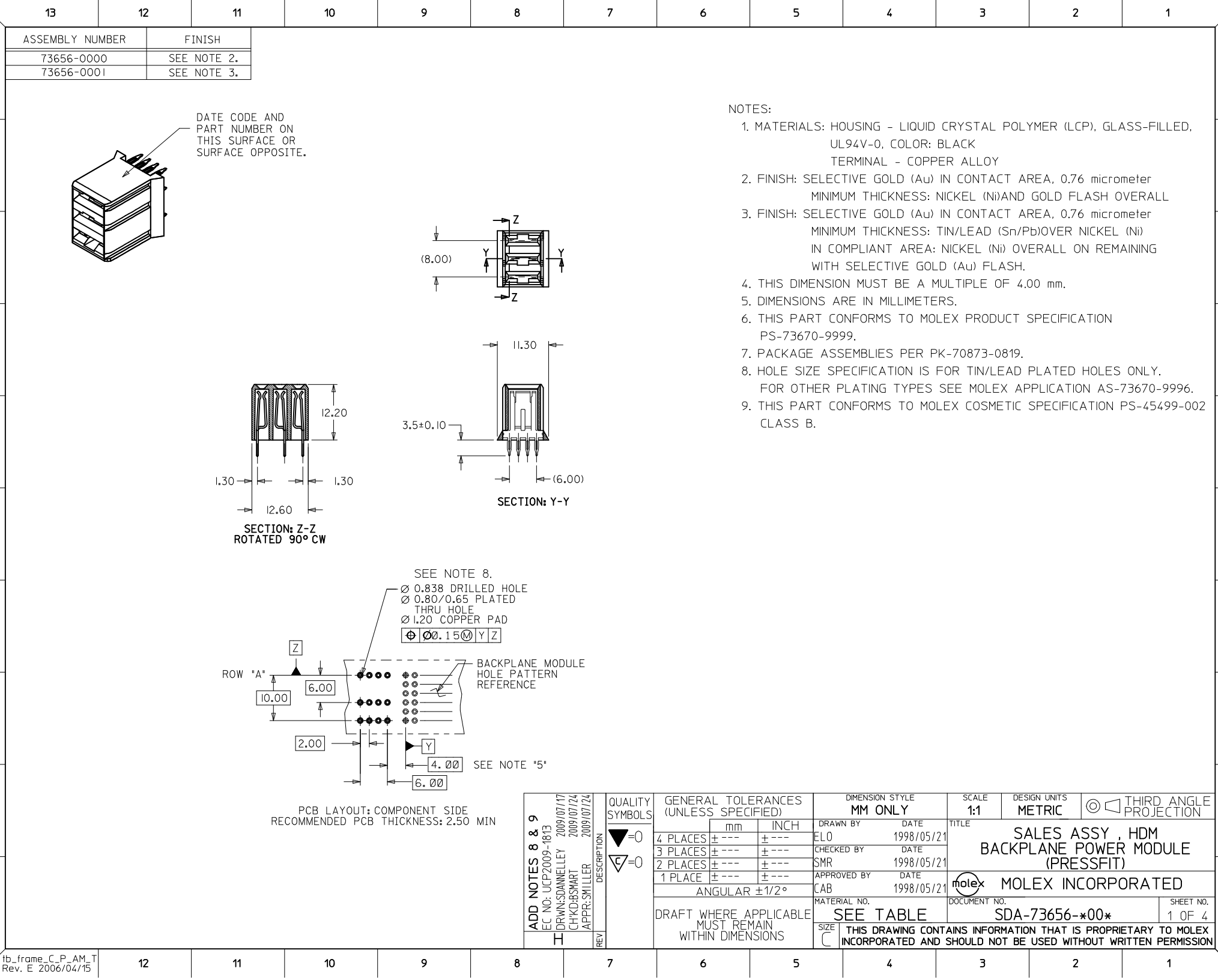
Reference - Drawing Numbers

Application Specification	AS-73656-1998
Packaging Specification	PK-70873-0819
Product Specification	PS-73670-9999
Sales Drawing	SDA-73656-*00*

HDM and High Density Metric are trademarks of Amphenol Corporation

This document was generated on 05/14/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION



10	9	8	7	6	5	4	3	2
----	---	---	---	---	---	---	---	---

ASSEMBLY NUMBER	FINISH (SEE SHT 1)
73656-1000	SEE NOTE 2. (GOLD TAILS)
73656-2000	
73656-1001	SEE NOTE 3. (TIN/LEAD TAILS)
73656-2001	

73656-200*

FROM SHEET

3.50 MIN

73656-200*

73656-100*

This diagram shows a cross-section of a multi-layer PCB. It features a central core with alternating layers of prepreg and copper. A through-hole is shown, with copper plating on the inner walls and a central copper pad. The top and bottom surfaces are also copper-plated.

SECTION: Y-Y

A cross-sectional diagram of a square hole. A central vertical pin is positioned within the hole. Two additional pins are located on the left and right sides of the hole, partially inserted. The hole is defined by a square frame with hatched areas indicating the material being removed.

SECTION: W-W

SEE SHEET 1	EC NO: UCP2009-1813 DRWN:SDANNELLEY CHKD:BSMART APPR:SMILLER	2009/07/17 2009/07/24 2009/07/24	DESCRIPTION	REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
							mm	INCH	DRAWN BY		DATE	TITLE SALES ASSY , HDM BACKPLANE POWER MODULE (PRESSFIT)  MOLEX INCORPORATED			
						4 PLACES	± ---	± ---	ELO		1998/05/21				
						3 PLACES	± ---	± ---	CHECKED BY		DATE				
						2 PLACES	± ---	± ---	SMR		1998/05/21				
						1 PLACE	± ---	± ---	APPROVED BY		DATE				
						ANGULAR ±1/2°		CAB		1998/05/21					
						DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
								SEE TABLE		SDA-73656-*00*		2 OF 4			
								THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

ASSEMBLY NUMBER

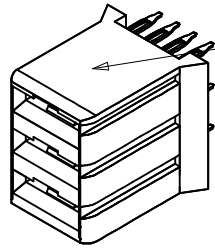
FINISH (SHT I)

73656-5000

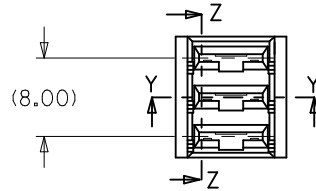
SEE NOTE 2.

73656-5001

SEE NOTE 3.



DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.



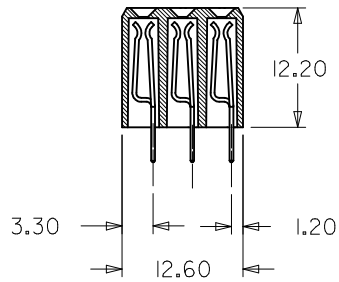
(8.00)

11.30

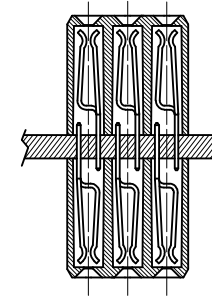
3.5±0.10

(6.00)

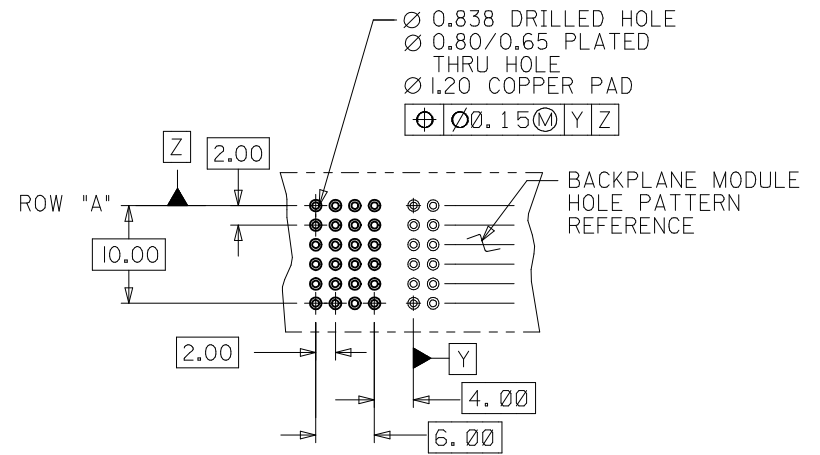
SECTION: Y-Y



SECTION: Z-Z
ROTATED 90° CW



2.36 MIN



SEE SHEET 1 EC NO: UCP2009-1813 DRWN: SDANIELLEY 2009/07/17 CHKD: BSMART 2009/07/24 APPR: SMILLER 2009/07/24	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
								TITLE SALES ASSY, HDM BACKPLANE POWER MODULE (PRESSFIT) MOLEX INCORPORATED	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. SEE TABLE	4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- ANGULAR ±1/2°		DRAWN BY DATE ELO 1998/05/21 CHECKED BY DATE SMR 1998/05/21 APPROVED BY DATE CAB 1998/05/21		DOCUMENT NO. SDA-73656-*00*		SHEET NO. 3 OF 4	
		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

ASSEMBLY NUMBER

FINISH

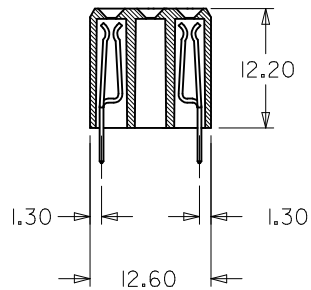
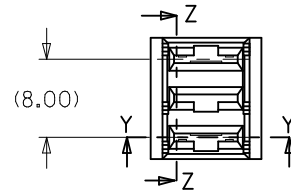
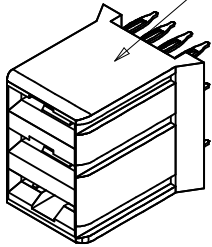
73656-0180

SEE NOTE 2.

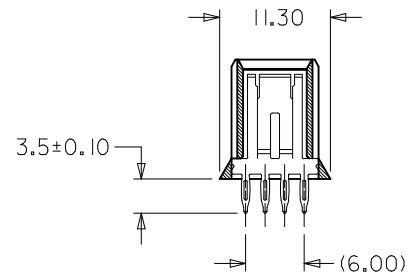
73656-0181

SEE NOTE 3.

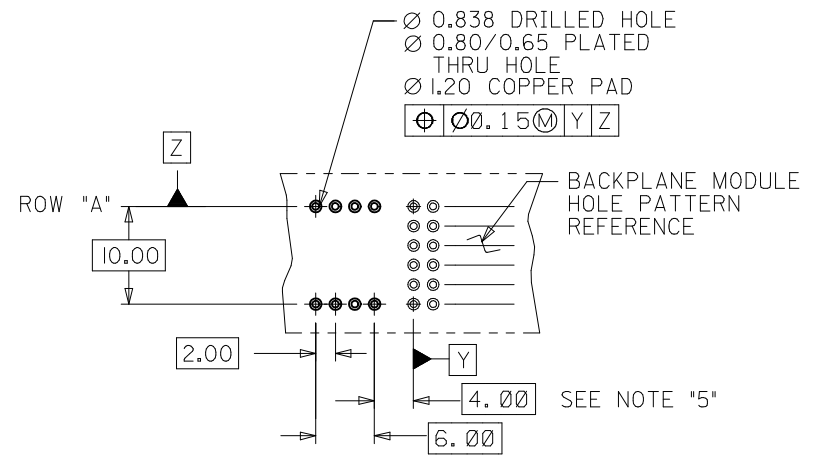
DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.



SECTION: Z-Z
ROTATED 90° CW



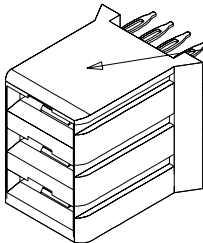
SECTION: Y-Y



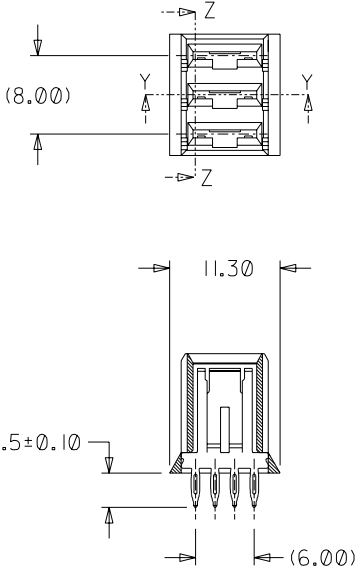
PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 2.50 MIN

SEE SHEET 1 EC NO: UCP2009-1813 DRWN:SDANIELLEY 2009/07/17 CHKD:SMART 2009/07/24 APPR:SMILLER 2009/07/24	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY	DATE	TITLE SALES ASSY , HDM BACKPLANE POWER MODULE (PRESSFIT)				
			4 PLACES	± ---	± ---	ELO	1998/05/21					
			3 PLACES	± ---	± ---	CHECKED BY	DATE					
			2 PLACES	± ---	± ---	SMR	1998/05/21	MOLEX INCORPORATED				
			1 PLACE	± ---	± ---	APPROVED BY	DATE					
			ANGULAR ±1/2°		CAB	1998/05/21	MOLEX					
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.		SHEET NO.			
					SEE TABLE		SDA-73656-*00*		4 OF 4			
REV	H	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION										

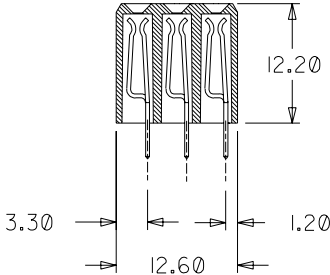
10	9	8	7	6	5	4	3	2	1
ASSEMBLY NUMBER		FINISH (SHT 1)							
73656-5000		SEE NOTE 2.							
73656-5001		SEE NOTE 3.							



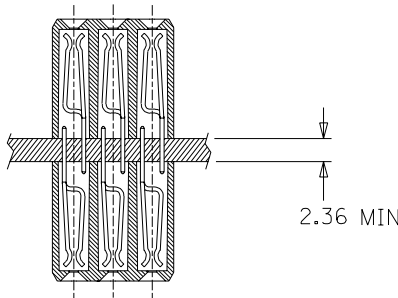
DATE CODE AND
PART NUMBER ON
THIS SURFACE OR
SURFACE OPPOSITE.



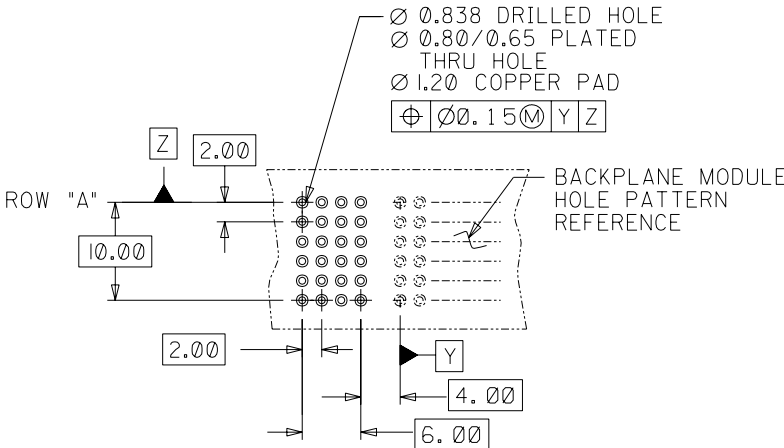
SECTION: Y-Y



SECTION: Z-Z
ROTATED 90° CW



2.36 MIN



Ø 0.838 DRILLED HOLE
Ø 0.80/0.65 PLATED
THRU HOLE
Ø 1.20 COPPER PAD
⊕ Ø0.15 (M) Y Z

ROW "A"

BACKPLANE MODULE
HOLE PATTERN
REFERENCE

		B		SEE SHEET 1		DIMENSIONS SHOWN (METRIC) INCH		REVISE ONLY ON CAD SYSTEM	
		G		SEE SHEET 1		UNLESS OTHERWISE SPECIFIED TOLERANCES: ANGULAR ± 1/2°		TITLE SALES ASSY, HDM BACKPLANE POWER MODULE (PRESS FIT)	
		E		SEE SHEET 1		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MOLEX INCORPORATED LITSE, ILL. 60532 U.S.A.	
LTR.		REVISIONS		LTR.		REVISIONS		PART NO. SEE CHART SDA-73656-*00*	

10	9	8	7	6	5	4	3	2	1
DRWG. BY: ELO		CHK'D. BY: SMR		FILE NAME: S73656X3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.		DIV. DA	
APP'D. BY: BIXLER		SCALE: 2 : 1		DGN				SIZE B	



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.